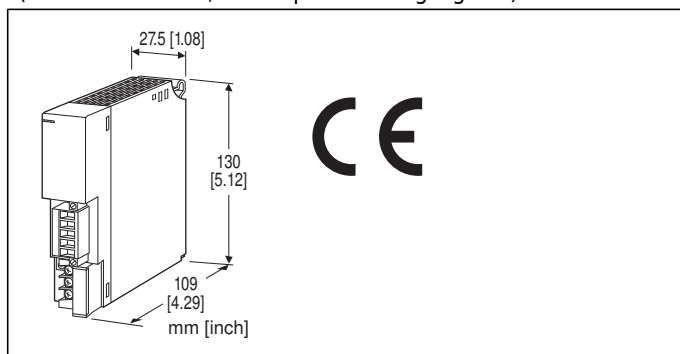


Remote I/O R3 Series

CC-Link INTERFACE MODULE

(CC-Link Ver.1.10; for 32-point analog signals)



MODEL: R3-NC2-[1][2]

ORDERING INFORMATION

- Code number: R3-NC2-[1][2]

Specify a code from below for each of [1] and [2].

(e.g. R3-NC2-R/CE/Q)

- Specify the specification for option code /Q

(e.g. /C01/SET)

[1] POWER INPUT

N: No power supply

AC Power

M2: 100 - 240 V AC

(Operational voltage range 85 - 264 V, 47 - 66 Hz)*

(CE not available)

K3: 100 - 120 V AC

(Operational voltage range 85 - 132 V, 47 - 66 Hz) *

(CE not available)

L3: 200 - 240 V AC

(Operational voltage range 170 - 264 V, 47 - 66 Hz) *

(CE not available)

DC Power

R: 24 V DC

(Operational voltage range 24 V ± 10 %, ripple 10 %p-p max.) *

* Not selectable for use with independent power modules or network modules with the internal power input options.

[2] OPTIONS (multiple selections)

Standards & Approvals

blank: Without CE

/CE: CE marking

Other Options

blank: none

/Q: Option other than the above (specify the specification)

SPECIFICATIONS OF OPTION: Q (multiple selections)

COATING (For the detail, refer to our web site.)

/C01: Silicone coating

/C02: Polyurethane coating

/C03: Rubber coating

EX-FACTORY SETTING

/SET: Preset according to the Ordering Information Sheet
(No. ESU-8355)

PACKAGE INCLUDES...

- Terminating resistor (110 Ω , 0.5 W)

GENERAL SPECIFICATIONS

Connection

CC-Link: Euro type connector terminal

(applicable wire size: 0.2 to 2.5 mm², stripped length 7 mm)

Internal bus: Via the Installation Base

(model: R3-BSx)

Internal power: Via the Installation Base (model: R3-BSx)

Power input, RUN contact output: M3 separable screw terminal (torque 0.5 N·m)

Screw terminal: Nickel-plated steel

Isolation: CC-Link to internal bus or internal power to power supply to RUN contact output to FG

Input error data setting: Input value setting at input module error with side DIP SW

Dual communication setting: Set with the side DIP switch

Data allocation setting: Set with the side DIP switch

RUN indicator: Bi-color (green/red) LED; Green ON in normal communication; Red ON when receiving data (Function selected with DIP SW)

ERR indicator: Bi-color (green/red) LED;

Green ON or blinking at communication error (OFF with cable disconnection, blinking in setting error); Red ON at transmitting data (Function selected with DIP SW)

■ RUN CONTACT OUTPUT

RUN contact: Turns ON while the green RUN LED is ON (CC-Link in normal communication).

Rated load: 250 V AC @ 0.5 A ($\cos \phi = 1$)

30 V DC @ 0.5 A (resistive load)

(Less than 50 V AC to conform with EU Directive)

Maximum switching voltage: 250 V AC or 30 V DC

Maximum switching power: 250 VA or 150 W

Minimum load: 1 V DC @ 1 mA

Mechanical life: 2×10^7 cycles (300 cycles/min.)

When driving an inductive load, external contact protection and noise quenching recommended.

CC-Link COMMUNICATION

CC-Link: Conforms to Version 1.10

Station No. setting: Rotary switch; 1 - 64

Baud rate setting: Rotary switch

156kbps, 625kbps, 2.5Mbps, 5Mbps, 10Mbps

Station type: Remote device station

Required nodes: 8 (4 stations × 2)

(128 I/O points, 16 words) × 2

(This unit incorporates two ASICs, each requires 4 stations (128 I/O points, 16 words), which are equivalent to two 4-station remote devices.)

Transmission cable: Approved for CC-Link

INSTALLATION

Power consumption

•AC

K3: Approx. 20 VA

L3: Approx. 28 VA

M2: Approx. 20 VA at 100 V AC

Approx. 28 VA at 200 V AC

•DC: Approx. 12 W

Current consumption (no power supply): 130 mA

Output current (power supply): 250 mA continuous at 20 V

DC; 400 mA for 10 minutes

Operating temperature: -10 to +55°C (14 to 131°F)

Operating humidity: 30 to 90 %RH (non-condensing)

Atmosphere: No corrosive gas or heavy dust

Mounting: Installation Base (model: R3-BSx)

Weight: 200 g (0.44 lb)

PERFORMANCE

Insulation resistance: ≥ 100 MΩ with 500 V DC

Dielectric strength: 1500 V AC @ 1 minute (CC-Link to internal bus or internal power to power input to RUN contact output to FG)

STANDARDS & APPROVALS

EU conformity:

EMC Directive

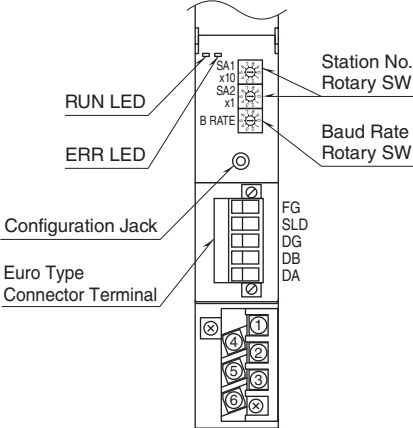
EMI EN 61000-6-4

EMS EN 61000-6-2

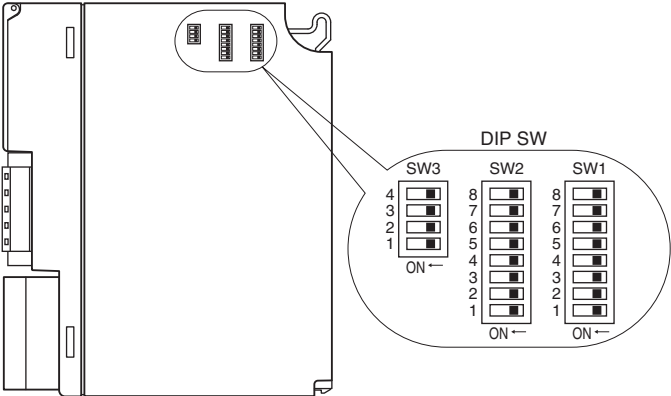
RoHS Directive

EXTERNAL VIEW

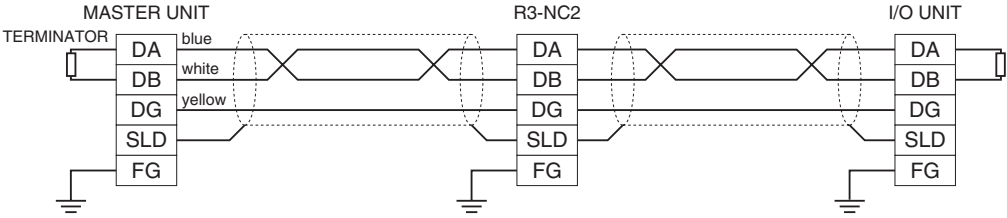
FRONT VIEW



SIDE VIEW



COMMUNICATION CABLE CONNECTIONS



TRANSMISSION DATA DESCRIPTIONS

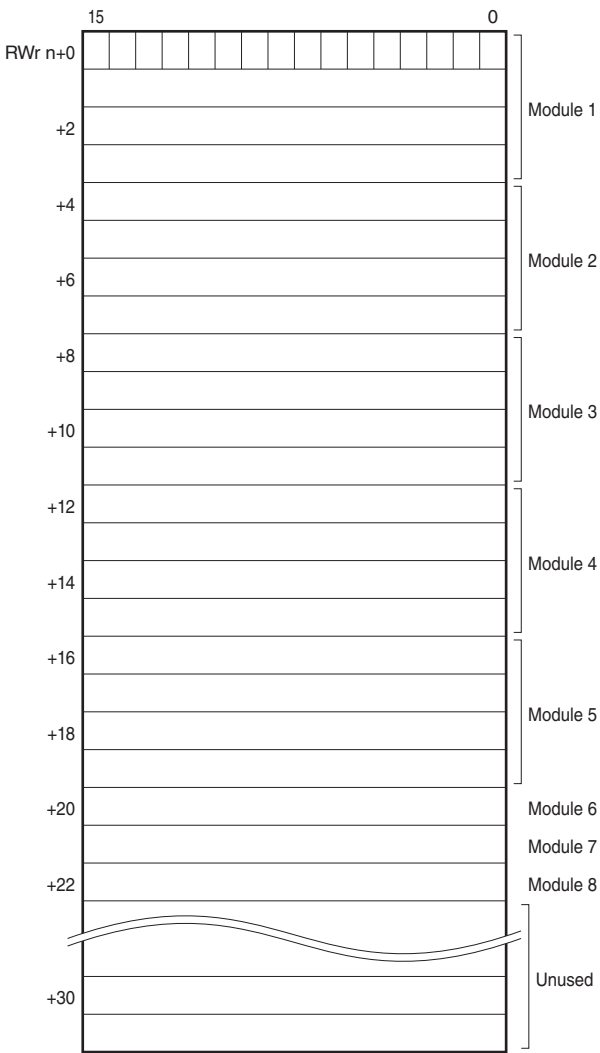
The DIP SW located at the side of the module specifies each I/O module's data allocation (occupied data area).
For example, when the data areas are assigned as shown below:

Module 1	4
Module 2	4
Module 3	4
Module 4	4
Module 5	4
Module 6	1
Module 7	1
Module 8	1

Then the I/O data are assigned as in the figures below:

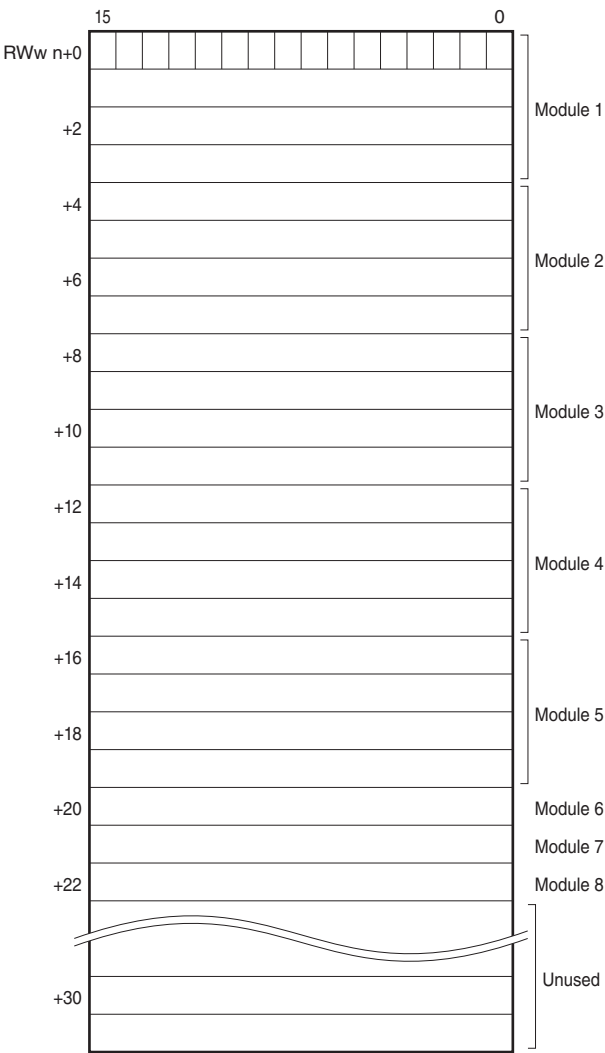
■ OUTPUT DATA

The figure below shows the allocation of the data sent from the network module to the master.

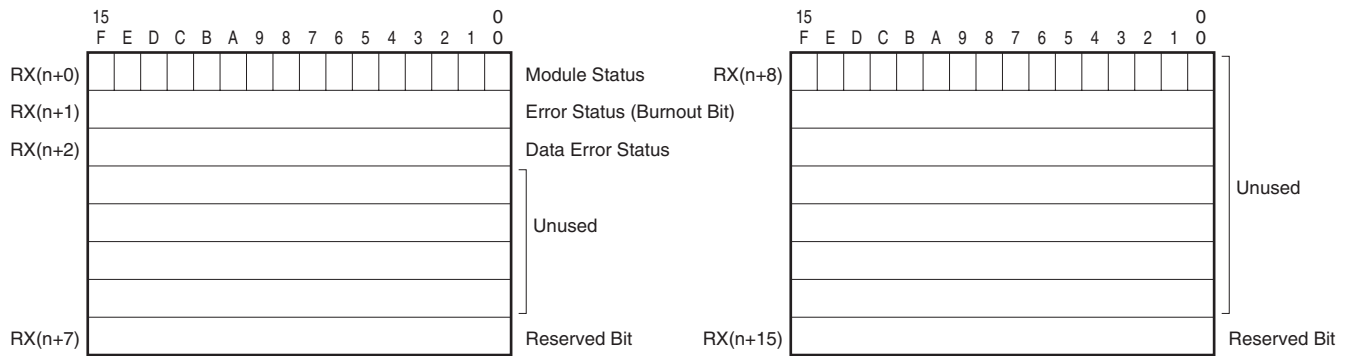


■ INPUT DATA

The figure below shows the allocation of the data sent from the master to the network module.



Thirty-two (32) data areas are available to this unit. Total data areas occupied by I/O modules must be within this limitation.



- **Module Status**

RX(n+0)0 through RX(n+0)F indicate whether individual I/O modules are mounted or not. The bit corresponding to the mounted slot turns to “1,” and the unmounted slot to “0.”

- **Error Status**

RX(n+1)0 through RX(n+1)F indicate error status for each module as described below. The bit corresponding to such module turns to “1.”

R3-TSx, R3-RSx, R3-US4: Input burnout
R3-DA16A: Power input in error or disconnected
R3-YSx: Output current error (e.g. load unconnected)
R3-PC16A: External power supply in error or disconnected

- **Data Error Status**

RX(n+2)0 through RX(n+2)F indicate overrange (R3-US4: out of -10% to +110%; the other types: out of -15% to +115%) status for each module. The bit corresponding to such module turns to “1.”

- RX(n+3) through RX(n+6) are unused.
RX(n+8) through RX(n+14) are unused.

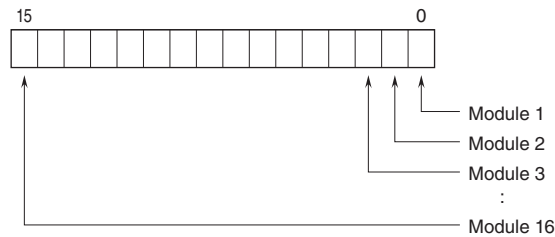
- RX(n+7)0 through RX(n+7)7 are reserved for future use. RX(n+7)B is assigned to Ready signal for ASIC 0, which is turned to “1” when the network module is in normal conditions. RX(n+7)8 through RX(n+7)A, RX(n+7)C through RX(n+7)F are not used.

RX(n+15)0 through RX(n+15)7 are reserved for future use. RX(n+15)B is assigned to Ready signal for ASIC 1, which is turned to “1” when the network module is in normal conditions. RX(n+15)8 through RX(n+15)A, RX(n+15)C through RX(n+15)F are not used.

RX(n+0) 0, RX(n+1) 0, RX(n+2) 0	Module 1
RX(n+0) 1, RX(n+1) 1, RX(n+2) 1	Module 2
RX(n+0) 2, RX(n+1) 2, RX(n+2) 2	Module 3
:	:
RX(n+0) F, RX(n+1) F, RX(n+2) F	Module 16

MODULE STATUS, ERROR STATUS, DATA ERROR STATUS

Shows each module's availability and error status.



I/O DATA DESCRIPTIONS

The data allocations for typical I/O modules are shown below.
Refer to the manual for each module for detailed data allocations.

■ ANALOG DATA (16-bit data, models: R3-SV4, YV4, DS4, YS4, US4, etc.)

16-bit binary data.
Basically, 0 to 100% of the selected I/O range is converted into 0 to 10000 (binary).
-15 to 0 % is a negative range represented in 2's complement.
In case of R3-US4, -10 to 0% is a negative range represented in 2's complement.



■ TEMPERATURE DATA (16-bit data, models: R3-RS4, TS4, US4, etc.)

16-bit binary data.
With °C temperature unit, raw data is multiplied by 10. For example, 25.5°C is converted into 255.
With °F temperature unit, the integer section of raw data is directly converted into the data.
For example, 135.4°F is converted into 135.
Minus temperature is converted into negative values, represented in 2's complements.



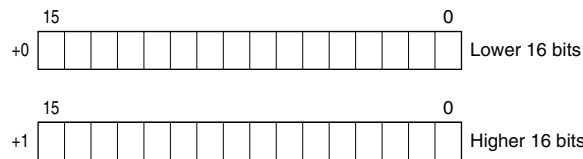
■ ANALOG DATA (16-bit data, models: R3-CT4A, CT4B, etc.)

16-bit binary data.
Integer obtained by multiplying unit value (A) by 100.
In case of CLSE-R5, integer obtained by multiplying unit value (A) by 1000.



■ ACCUMULATED COUNT DATA (32-bit data, models: R3-PA2, PA4A, WT1, WT4, etc.)

32-bit binary data is used for accumulated counts and encoder positions.
Lower 16 bits are allocated from the lowest address to higher ones, higher 16 bits in turn.



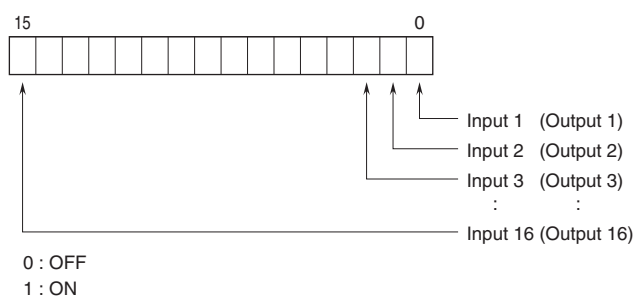
■ BCD DATA (32-bit data, models: R3-BA32A, BC32A, etc.)

32-bit binary data is used for BCD.

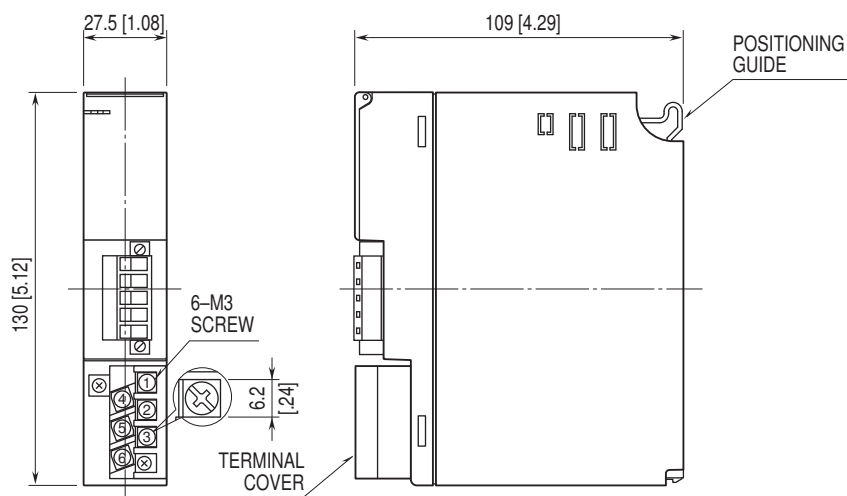
Lower 16 bits are allocated from the lowest address to higher ones, higher 16 bits in turn.



■ 16-POINT DISCRETE DATA (models: R3-DA16, DC16, etc.)



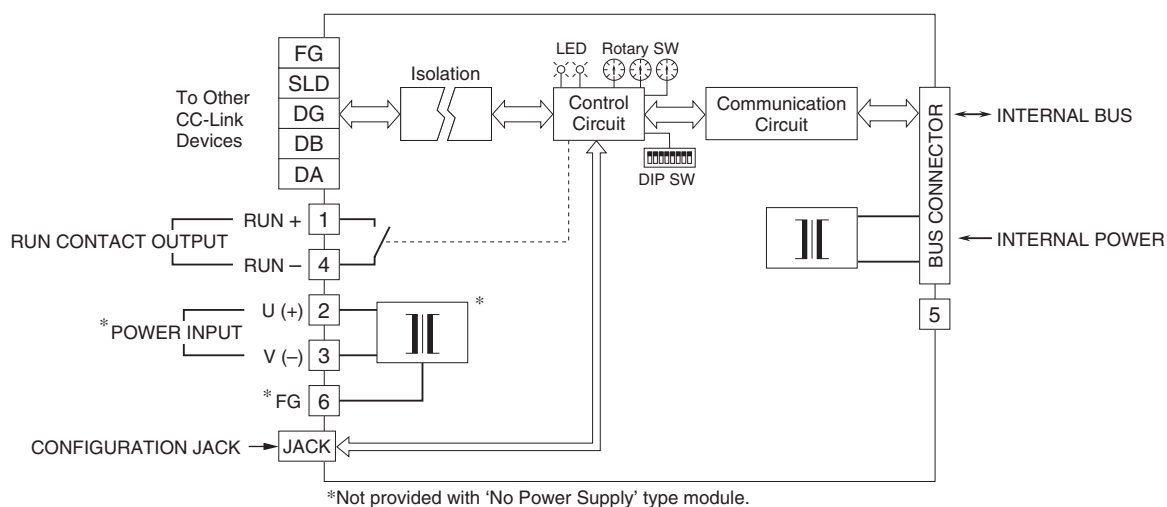
EXTERNAL DIMENSIONS & TERMINAL ASSIGNMENTS unit: mm [inch]



SCHEMATIC CIRCUITRY & CONNECTION DIAGRAM

Note: In order to improve EMC performance, bond the FG terminal to ground.

Caution: FG terminal is NOT a protective conductor terminal.



Specifications are subject to change without notice.